

Electronics Equipment Company  
Advanced Material Equipment Company



We would like to extend our sincere appreciation to all those who visited the **Takatori Corporation booth at SEMICON India 2026**, held from September 17 to 19, 2026.

It was our great pleasure to welcome so many distinguished guests, and we are deeply grateful for the time you took to visit our booth.

The products we exhibited at the show,

**PLP-700 (Panel Level Packaging System),**

**MWS-SiC12F (12-inch Multi-Wire Saw), GLP-150 (Grinder for Superhard Materials)**

received a great deal of interest and highly positive feedback from many visitors, for which we are truly grateful. We also sincerely appreciate the valuable comments and questions we received during the exhibition. We will make full use of your feedback in our future product development and technical proposals. Going forward, we will continue to place great importance on close communication with our customers and strive to create new value through **customer co-creation**, while providing even more advanced and value-added solutions.

Should you have any comments, questions, or inquiries regarding the products introduced at the exhibition, or if you would like further information about demonstrations or evaluation tests, please feel free to contact us at any time.

We sincerely appreciate your continued support of **Takatori Corporation** and look forward to serving you in the future.

